







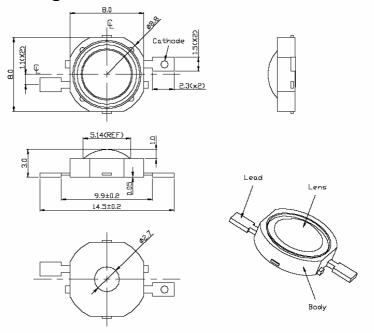
Features

- Highest Lumen Per Watt
- Long Operational Life
- White Housing
- Superior ESD Protection
- Instant Light (less than 100ns)
- Compatible to Luxeon's "Lambertian"
- True SMD Emitter
- IR Reflow Soldering Process

Applications

- Accent Light/Down Light/Spot Light
- Automotive Exterior/Interior Light
- Large Area LCD Backlights
- Marine/Miner's Lighting
- Portable Flashlight/ General Lighting

Package Dimension



Note: Lens is low dome profile

Tolerance: ± see spec Unit: mm

Optical Characteristics at T_J=25°C, I_F=700mA

PART NUMBER	Emitting Color	LED Chip	Lens Color	Wavelen CCT (K)	• • •	Drive Voltage @ 700mA	Luminous Flux (lm) @700mA	VIEW ANGLE 2θ _{1/2}
			COIOI	Min	Max	Тур.	Тур.	(deg)
BTP3-99NRCG-XX-X/W	Normal Red		Water Clear	620	635	2.40V	60 lm	
BTP3-99AMCG-XX-X/W	Amber	AllnGaP	Water Clear	610	620	2.40V	72 lm	
BTP3-99YECG-XX-X/W	Yellow		Water Clear	585	595	2.40V	60 lm	
BTP3-99BLCG-XX-X/W	Blue		Water Clear	460	475	3.50V	20 lm	140
BTP3-99PGCG-XX-X/W	Green	AllnGaN	Water Clear	520	540	3.50V	60 lm	
BTP3-99WWCG-XX-X/W	Warm White		Water Clear	2800K	3800K	3.50V	40 lm	
BTP3-99WHCG-XX-X/W	White		Water Clear	5000K	8000K	3.50V	60 lm	

Notes:

- 1) Picture for illustration purpose only. Please refer to outline dimension for actual package size.
- 2) Flux is measured with the accuracy of ±15%. Please refer to Flux Selection Guide
- 3) CCT is measured with the accuracy of \pm 400K. Please refer to CCT Selection Guide
- 4) V_F is measured with the accuracy of \pm 0.15V. Please refer to V_F Selection Guide

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BTP3-99XXCG-XX-X/W

Absolute Maximum Ratings at T_J=25°C

Parameter	Red/Amber/Yellow	White/Blue/Green
Power Dissipation (W)	2.17	2.80
DC Forward Current (mA) ^[1]	700	700
Peak Pulsed Forward Current (mA) [4]	1000	1000
Average Forward Current (mA)	700	700
Reverse Voltage (V)	5	5
Reverse Current (uA)	50	50
ESD Sensitivity (V) [2]	16,000	16,000
LED Junction Temperature at 350mA (°C) [3]	120	135
Thermal Resistance Junction to Board (°C/W)	13	13
Temperature Coefficient of V _F (mV/°C)	-2	-2
Storage Temperature (°C)	-40 to +105	-40 to +105
Operating Temperature (°C)	-40 to +105	-40 to +105
Lead Soldering Temperature (°C) ^[4]	260°C for 5 seconds max	260°C for 5 seconds max

Application Notes:

- Proper forward current must be observed to maintain the junction temperature below maximum rating
- 2. Although all products listed are class one ESD protection (+/- 16KV by HBM mode), care must be fully taken when handling products
- 3. Specification is subjected to change for improvements without notice.
- 4. Test conditions: tp≤10us, duty cycle = 0.005
- 5. CAUTION: When lighting up, the emitter will become very hot if it is not attached to a heat sink.

 Please provide proper heat management to prevent damage to the emitter.

WARNING
This range of LEDs is produced with die having a high radiant flux.
Care must be taken when viewing the product at close range as the light may be intense enough to cause damage to the human eye.

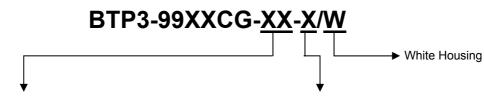
Note: Industry standard procedures regarding static must be observed when handling this product.

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CCT, Flux and V_F Selection Guide (@T_J=25°C, I_F=700mA)



Wavelength Ranks Selection

Travolongin ranko oblobilon				
Color	Bin	λ _D (nm)		
COIOI		Min	Max	
Blue	B 5	460	465	
	В6	465	470	
	B7	470	475	
	XX	460 – 475		
Green	G6	515	520	
	G7	520	525	
	G8	525	530	
	G9	530	535	
	XX	515 – 535		
Red	XX	620 – 630		
Amber	XX	610 – 620		
Yellow	XX	585 – 595		

Flux Ranks Selection

Color	Bin	Flux (lumens)	
	K	8~10	
Blue	L	10~14	
Diue	M	14~18	
	X	Default Full Range	
	Q	30~39	
Red	R	39~50	
Amber Yellow	S	50~65	
Green White	Т	65~85	
	U	85~111	
	Х	Default Full Range	

CCT Ranks Selection

Color	Bin	CCT(K)		
Temp	DIII	Min	Max	
Warm White	00	2800	3300	
	01	3300	3800	
	XX	2800K – 3800K		
White	02	5000	6000	
	03	6000	7000	
	04	7000	8000	
	XX	5000K – 8000K		

V_F Ranks Selection

Color	Bin	V _F (V)		
Coloi	DIII	Min	Max	
	V04	2.0	2.2	
Red	V05	2.2	2.4	
Amber	V06	2.4	2.6	
Yellow	V07	2.6	2.8	
	VXX(Full)	2.0~2.8		
	V08	2.8	3.0	
387 17	V09	3.0	3.2	
White Blue	V10	3.2	3.4	
Green	V11	3.4	3.6	
	V12	3.6	3.8	
	VXX(Full)	2.8~3.8		

(Please specify on order, otherwise, default full range of V_F)

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ProLite 3W SMD Emitter

BTP3-99XXCG-XX-X/W

Typical Electro-Optical Characteristics Curves

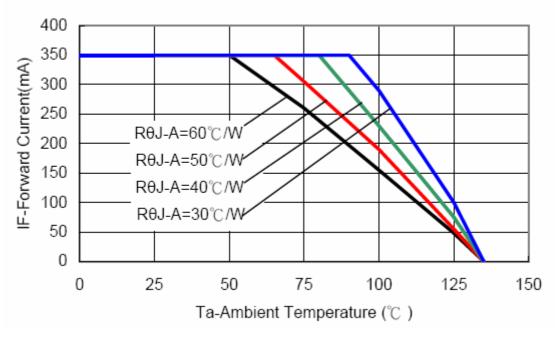


Fig. 1 Forward Current vs Ambient Temperature (Green, Blue and White)

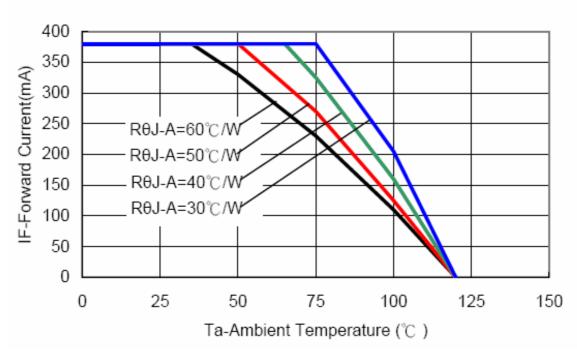


Fig. 2 Forward Current vs Ambient Temperature (Red, Amber and Yellow)

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ProLite 3W SMD Emitter

BTP3-99XXCG-XX-X/W

Forward Current Characteristics, Tj=25°C

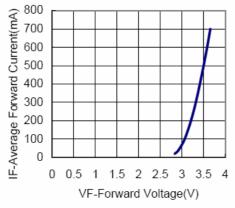


Fig 3a. Forward Current vs. Forward Voltage for White, Warm White, Blue and Green.

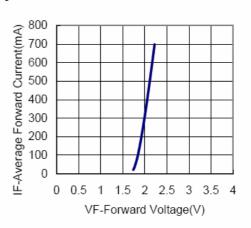


Fig 3b. Forward Current vs. Forward Voltage for Amber, Red-Orange and Red.

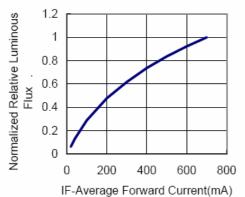


Fig 4a. Relative Luminous Flux vs. Forward Current for White, Warm White, Blue and Green at Tj=25°C maintained.

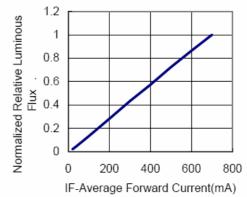


Fig 4b. Relative Luminous Flux vs. Forward Current for Amber, Red-Orange, Red at Tj=25°ℂ maintained.





Typical Electro-Optical Characteristics Curves

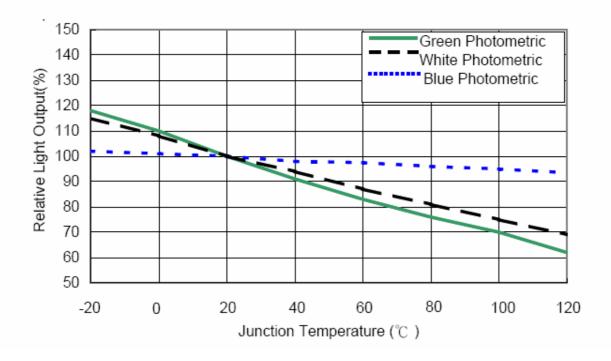


Fig. 5a Relative Light Output vs Junction Temperature

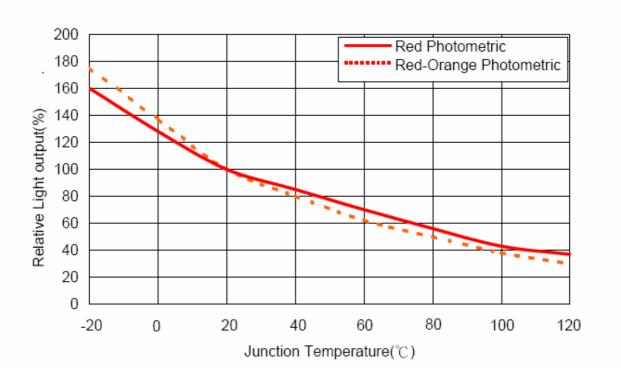


Fig. 5b Relative Light Output vs Junction Temperature

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Typical Electro-Optical Characteristics Curves

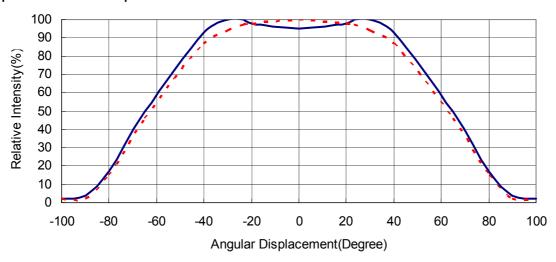


Fig. 6 Typical Radiation Pattern

Recommended Solder Pad Layout

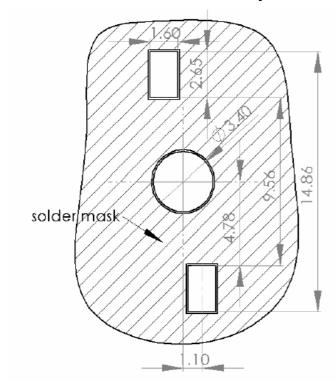


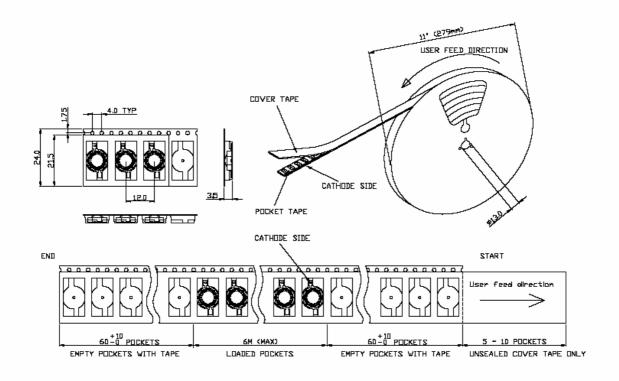
Fig. 7 Recommended Solder Pads Dimension

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Tape and Reel Packaging Dimension



Notes:

- The emitters should be picked up by the body (not the lens) during placement. The inner diameter of the pick-up collet should be greater than or equal to 6.5 mm.
- 2. Drawing not to scale.
- 3. All dimensions are in millimeters.
- 4 .All dimendions without tolerances are for reference only.

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ProLite 3W SMD Emitter

BTP3-99XXCG-XX-X/W

Recommended IR Reflow Conditions

Reflow Soldering				
	Lead Solder	Lead-Free Solder		
Pre-heat	120~150°C	180~200°C		
Pre-heat time	120 sec Max	120 sec Max		
Peak Temperature	240°C Max	260°C Max		
Soldering Time	10 sec Max	10 sec Max		
Conditions	Refer to Temperature profile A	Refer to Temperature profile B (N ₂ reflow is recommended)		

Temperature Profile A (Surface of MCPCB)

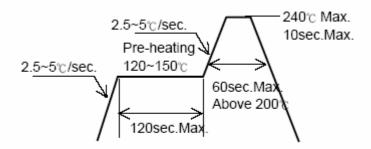


Figure 8a. Lead Solder Temperature Profile

Temperature Profile B (Surface of MCPCB)

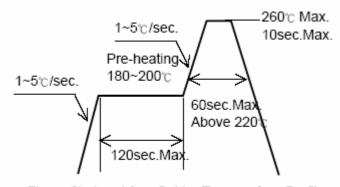


Figure 8b. Lead-free Solder Temperature Profile

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IR Reflow Process Notes

- Occasionally there is a brightness decrease due to the influence of heat or ambient during air reflow. It is recommended that customer use nitrogen reflow method.
- Repairing should not be done after the LEDs have been soldered. When repairing is required, double-head soldering iron should be used. Customer should confirm whether the characteristics of the LEDs will or will not damaged before carrying out the repair.
- Reflow soldering should not be done more than two times
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.

Manual Hand Soldering Notes

- For prototype builds or small production runs, it is possible to place and solder the emitters.
- It is recommended to hand solder the leads and slug with a solder tip temperature of 230°C for less than 10seconds. This profile ensures a junction temperature below the maximum of 120°C, avoiding damage to the emitter or to the MCPCB dielectric layer. Damage dielectric layer can cause a short circuit in the array.

Other Important Notes:

- The information contained herein is presented only as a Guide for the application of our products. Brilliance Technologies assumes no responsibility for any infringement of intellectual property or other rights of the third parties which may result from its use.
- Brilliance Technologies continually improves the quality of our products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsible of the customer, when using Brilliance Technologies products, to comply with the standard of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such Brilliance Technologies products cause loss of human life, bodily injury or damage to property.
- Brilliance Technologies products listed in this data sheet are intended for usage in general
 electronics and/or non-commercial or industrial lighting products. These products are neither
 intended nor warranted for usage in equipment that requires extraordinarily high quality and/or
 reliability or a malfunction or failure of which may cause loss of human life or bodily injury.
- In developing your design, please ensure that Brilliance Technologies products are used within specified operating ranges as set forth in the most recent Brilliance Technologies data sheets.

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